

Product code: M386B4G70DM0-YK04

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Samsung M386B4G70DM0-YK04. Component for: PC/Server, Internal memory: 32 GB, Memory layout (modules x size): 4 x 8 GB, Internal memory type: DDR3L, Memory clock speed: 1600 MHz, Memory form factor: 240-pin DIMM, CAS latency: 11, ECC

Features		Features	
CAS latency	11	ECC *	✓
Internal memory *	32 GB	Buffered memory type	Registered (buffered)
Memory layout (modules x size) *	4 x 8 GB	Memory ranking	4
Internal memory type *	DDR3L	Memory voltage	1.35 V
Memory clock speed	1600 MHz	Module configuration	4096M x 72
Component for *	PC/Server		
Memory form factor *	240-pin DIMM	Operational conditions	
		Operating temperature (T-T)	0 - 85 °C
		Weight & dimensions	
		Height	30.4 mm



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Catalog Object Cloud



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